

# PATENT ASSIGNMENT

Electronic Version v1.1

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT										
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT										
<b>CONVEYING PARTY DATA</b>											
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Kun-Mu Lee</td> <td>12/28/2009</td> </tr> <tr> <td>Yung-Liang Tung</td> <td>12/28/2009</td> </tr> </tbody> </table>		Name	Execution Date	Kun-Mu Lee	12/28/2009	Yung-Liang Tung	12/28/2009				
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<b>RECEIVING PARTY DATA</b>											
<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;"><b>Name:</b></td> <td>INDUSTRIAL TECHNOLOGY RESEARCH INSTITUTE</td> </tr> <tr> <td><b>Street Address:</b></td> <td>No. 195, Sec. 4, Chung Hsing Rd., Chutung</td> </tr> <tr> <td><b>City:</b></td> <td>Hsinchu County</td> </tr> <tr> <td><b>State/Country:</b></td> <td>TAIWAN</td> </tr> <tr> <td><b>Postal Code:</b></td> <td>31040</td> </tr> </table>		<b>Name:</b>	INDUSTRIAL TECHNOLOGY RESEARCH INSTITUTE	<b>Street Address:</b>	No. 195, Sec. 4, Chung Hsing Rd., Chutung	<b>City:</b>	Hsinchu County	<b>State/Country:</b>	TAIWAN	<b>Postal Code:</b>	31040
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<b>CORRESPONDENCE DATA</b>											
<p>Fax Number: (206)374-2899</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: (206)372-3162</p> <p>Email: DPAI@PAILAW.COM</p> <p>Correspondent Name: C. DAVID PAI</p> <p>Address Line 1: 1001 FOURTH AVENUE, SUITE 3200</p> <p>Address Line 4: SEATTLE, WASHINGTON 98154</p>											
<b>ATTORNEY DOCKET NUMBER:</b>	0974-A23344-US										
<b>NAME OF SUBMITTER:</b>	C. David Pai										
<p>Total Attachments: 1</p> <p>source=0974-A23344US-A#page1.tif</p>											

OP \$40.00 12790803

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**PATENT**  
**REEL: 024459 FRAME: 0831**

## ASSIGNMENT

WHEREAS, Kun-Mu LEE and Yung-Liang TUNG hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: METHOD FOR MANUFACTURING AN ELECTRODE

Filed: \_\_\_\_\_ Serial No. \_\_\_\_\_

Executed on: 2009.12.28 and 2009.12.28

WHEREAS, Industrial Technology Research Institute of No. 195, Sec. 4, Chung Hsing Rd., Chutung, Hsinchu 31040, Taiwan, R. O. C. hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Full name of sole or first inventor: Kun-Mu LEE	
Inventor's signature: <i>Kun-Mu Lee</i>	Date: 2009.12.28

Full name of second inventor: Yung-Liang TUNG	
Inventor's signature: <i>Yung-Liang Tung</i>	Date: 2009.12.28